

CD4511B Types

CMOS BCD-to-7-Segment Latch Decoder Drivers

High-Voltage Types (20-Volt Rating)

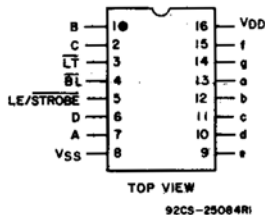


■ CD4511B types are BCD-to-7-segment latch decoder drivers constructed with CMOS logic and n-p-n bipolar transistor output devices on a single monolithic structure. These devices combine the low quiescent power dissipation and high noise immunity features of RCA CMOS with n-p-n bipolar output transistors capable of sourcing up to 25 mA. This capability allows the CD4511B types to drive LED's and other displays directly.

Lamp Test (LT), Blanking (BL), and Latch Enable or Strobe inputs are provided to test the display, shut off or intensity-modulate it, and store or strobe a BCD code, respectively. Several different signals may be multiplexed and displayed when external multiplexing circuitry is used.

The CD4511B types are supplied in 16-lead hermetic dual-in-line ceramic packages (F3A suffix), 16-lead dual-in-line plastic packages (E suffix), 16-lead small-outline packages (NSR suffix), and 16-lead thin shrink small-outline packages (PW and PWR suffixes).

These devices are similar to the type MC14511.



**CD4511B
TERMINAL ASSIGNMENT**

Features:

- High-output-sourcing capability up to 25 mA
- Input latches for BCD Code storage
- Lamp Test and Blanking capability
- 7-segment outputs blanked for BCD input codes > 1001
- 100% tested for quiescent current at 20 V
- Max. input current of 1 μ A at 18 V, over full package-temperature range, 100 nA at 18 V and 25°C
- 5-V, 10-V, and 15-V parametric ratings

Applications:

- Driving common-cathode LED displays
- Multiplexing with common-cathode LED displays
- Driving incandescent displays
- Driving low-voltage fluorescent displays

MAXIMUM RATINGS, Absolute-Maximum Values:

DC SUPPLY-VOLTAGE RANGE, (V_{DD})

Voltages referenced to V_{SS} Terminal) -0.5V to +20V

INPUT VOLTAGE RANGE, ALL INPUTS -0.5V to V_{DD} +0.5V

DC INPUT CURRENT, ANY ONE INPUT ± 10 mA

POWER DISSIPATION, PER PACKAGE (P_D):

For $T_A = -55^\circ\text{C}$ to $+100^\circ\text{C}$ 500mW

For $T_A = +100^\circ\text{C}$ to $+125^\circ\text{C}$ Derate Linearly at 12mW/ $^\circ\text{C}$ to 200mW

DEVICE DISSIPATION PER OUTPUT TRANSISTOR

FOR $T_A = \text{FULL PACKAGE-TEMPERATURE RANGE (All Package Types)}$ 100mW

OPERATING-TEMPERATURE RANGE (T_A) -55°C to $+125^\circ\text{C}$

STORAGE TEMPERATURE RANGE (T_{stg}) -65°C to $+150^\circ\text{C}$

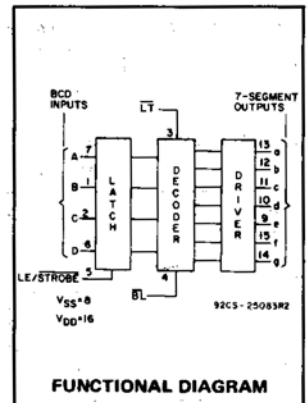
LEAD TEMPERATURE (DURING SOLDERING):

At distance 1/16 $\pm$ 1/32 inch (1.59 $\pm$ 0.79mm) from case for 10s max $+265^\circ\text{C}$

OPERATING CONDITIONS AT $T_A = 25^\circ\text{C}$ Unless Otherwise Specified

For maximum reliability, nominal operating conditions should be selected so that operation is always within the following ranges

Characteristic	V_{DD}	Min.	Max.	Units
Supply Voltage Range (T_A): (Full Package-Temperature Range)	—	3	18	V
Set-Up Time (t_S)	5	150	—	ns
	10	70	—	ns
	15	40	—	ns
Hold Time (t_H)	5	0	—	ns
	10	0	—	ns
	15	0	—	ns
Strobe Pulse Width (t_W)	5	400	—	ns
	10	160	—	ns
	15	100	—	ns



CD4511B Types

STATIC ELECTRICAL CHARACTERISTICS

CHARACTERISTIC	TEST CONDITIONS				LIMITS AT INDICATED TEMPERATURES (°C)							Units
	I _{OH} (mA)	V _O (V)	V _{IN} (V)	V _{DD} (V)					+25			
					-55	-40	+85	+125	Min.	Typ.	Max.	
Quiescent Device Current: I _{DD} Max.	—	—	—	5	5	5	150	150	—	0.04	5	μA
	—	—	—	10	10	10	300	300	—	0.04	10	
	—	—	—	15	20	20	600	600	—	0.04	20	
	—	—	—	20	100	100	3000	3000	—	0.08	100	
Output Voltage:												
Low-Level V _{OL} Max.	—	—	0.5	5	0.05				—	0	0.05	V
	—	—	0.10	10	0.05				—	0	0.05	
	—	—	0.15	15	0.05				—	0	0.05	
High-Level V _{OH} Min.	—	—	0.5	5	4	4	4.2	4.2	4.1	4.55	—	V
	—	—	0.10	10	9	9	9.2	9.2	9.1	9.55	—	
	—	—	0.15	15	14	14	14.2	14.2	14.1	14.55	—	
Input Low Voltage, V _{IL} Max.	—	0.5,3.8		5	1.5				—	—	1.5	V
	—	1.8,8	—	10	3				—	—	3	
	—	1.5,13.8	—	15	4				—	—	4	
Input High Voltage, V _{IH} Min.	—	0.5,3.8		5	3.5				3.5	—	—	V
	—	1.8,8	—	10	7				7	—	—	
	—	1.5,13.8	—	15	11				11	—	—	
Output Drive Voltage: High Level V _{OH} Min.	0			5	4.0	4.0	4.20	4.20	4.10	4.55	—	V
	5	—	—		—	—	—	—	—	4.25	—	
	10	—	—		3.80	3.80	3.90	3.90	3.90	4.10	—	
	15	—	—		—	—	3.50	3.50	—	3.95	—	
	20	—	—		3.55	3.55	3.30	—	3.40	3.75	—	
	25	—	—	3.40	3.40	—	—	3.10	3.55	—	V	
	0	—	—	9.0	9.0	9.20	9.20	9.10	9.55	—		
	5	—	—	—	—	—	—	—	9.25	—		
	10	—	—	8.85	8.85	9.00	9.00	9.00	9.15	—		
	15	—	—	—	—	—	—	—	9.05	—		
	20	—	—	8.70	8.70	8.40	8.40	8.60	8.90	—	V	
	25	—	—	8.60	8.60	—	—	8.30	8.75	—		
	0	—	—	14.0	14.0	14.20	14.20	14.10	14.55	—		
	5	—	—	—	—	—	—	—	14.30	—		
	10	—	—	13.90	13.90	14.0	14.0	14.0	14.20	—		
	15	—	—	—	—	—	—	—	14.10	—	V	
	20	—	—	13.75	13.75	13.50	13.50	13.70	13.95	—		
	25	—	—	13.65	13.65	—	—	13.50	13.80	—		
Output Low (Sink) Current, I _{OL} Min.	—	0.4	0.5	5	0.64	0.61	0.42	0.36	0.51	1	—	mA
	—	0.5	0.10	10	1.6	1.5	1.1	0.9	1.3	2.6	—	
	—	1.5	0.15	15	4.2	4	2.8	2.4	3.4	6.8	—	
Input Current, I _{IN} Max.	—	0.18	0.18	18	±0.1	±0.1	±1	±1	—	±10 ⁻⁵	±0.1	μA
	—	—	—	—	—	—	—	—	—	—	—	

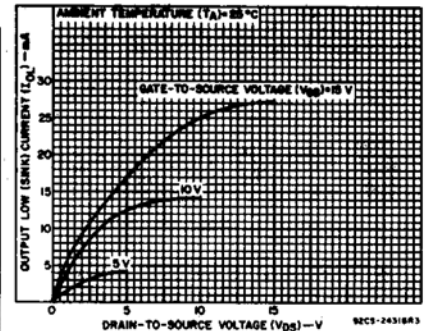


Fig. 1 – Typical output low (sink) current characteristics.

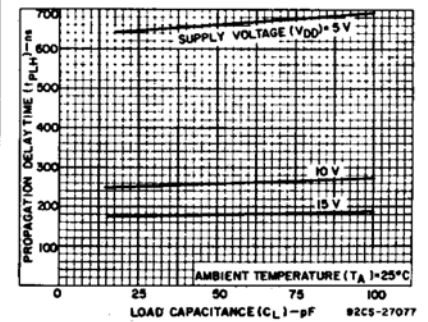


Fig. 2 – Typical data-to-output, low-to-high-level propagation delay time as a function of load capacitance.

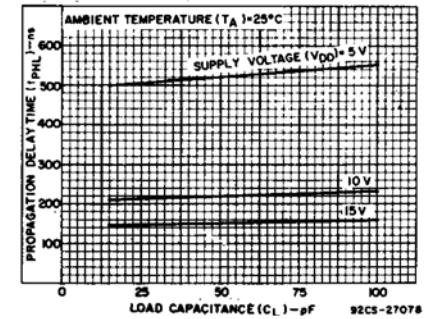


Fig. 3 – Typical data-to-output, high-to-low-level propagation delay time as a function of load capacitance.

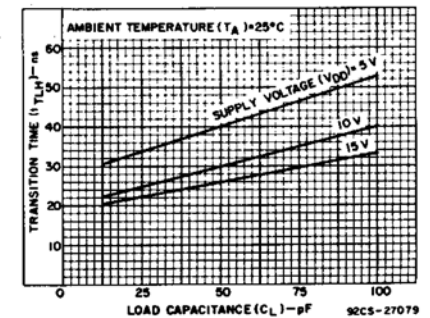


Fig. 4 – Typical low-to-high-level transition time as a function of load capacitance.

CD4511B Types

DYNAMIC ELECTRICAL CHARACTERISTICS at $T_A = 25^\circ\text{C}$, Input $t_r, t_f = 20\text{ ns}$,
 $C_L = 50\text{ pF}$, $R_L = 200\text{ k}\Omega$

CHARACTERISTIC	Test Conditions	LIMITS All Packages			UNITS
	V_{DD} Volts	Min.	Typ.	Max.	
Propagation Delay Time: (Data) High-to-Low Level, t_{PHL}	5 10 15	— — —	520 210 150	1040 420 300	ns
Low-to-High Level, t_{PLH}	5 10 15	— — —	660 260 180	1320 520 360	ns
Propagation Delay Time: (BL) High-to-Low Level, t_{PHL}	5 10 15	— — —	350 175 125	700 350 250	ns
Low-to-High Level, t_{PLH}	5 10 15	— — —	400 175 150	800 350 300	ns
Propagation Delay Time: (LT) High-to-Low Level, t_{PHL}	5 10 15	— — —	250 125 85	500 250 170	ns
Low-to-High Level, t_{PLH}	5 10 15	— — —	150 75 50	300 150 100	ns
Transition Time: Low-to-High Level, t_{TLH}	5 10 15	— — —	40 30 25	80 60 50	ns
High-to-Low Level, t_{THL}	5 10 15	— — —	125 75 65	310 185 160	ns
Minimum Set-Up Time, t_S	5 10 15	150 70 40	75 35 20	— — —	ns
Minimum Hold Time, t_H	5 10 15	0 0 0	-75 -35 -20	— — —	ns
Strobe Pulse Width, t_W	5 10 15	400 160 100	200 80 50	— — —	ns
Input Capacitance, C_{IN}		—	5	7.5	pF

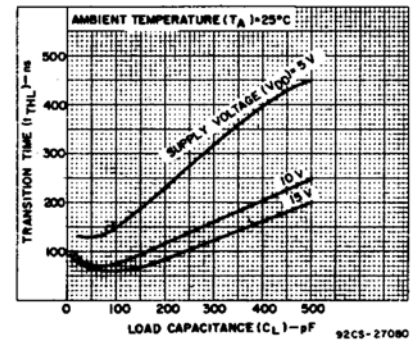


Fig. 5 — Typical high-to-low transition time as a function of load capacitance.

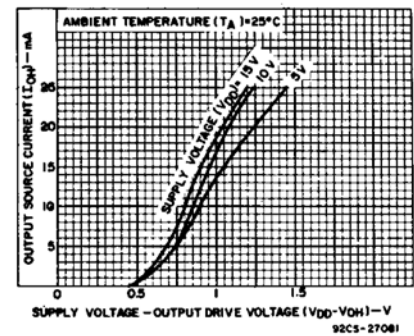


Fig. 6 — Typical voltage drop (V_{DD} to output) vs. output source current as a function of supply.

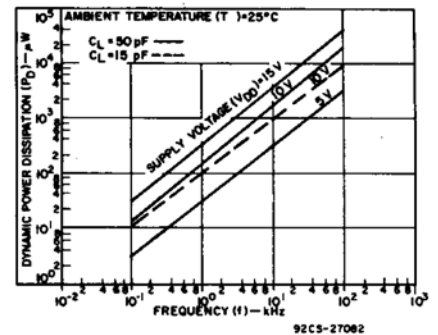


Fig. 7 — Typical dynamic power dissipation characteristics.

CD4511B Types

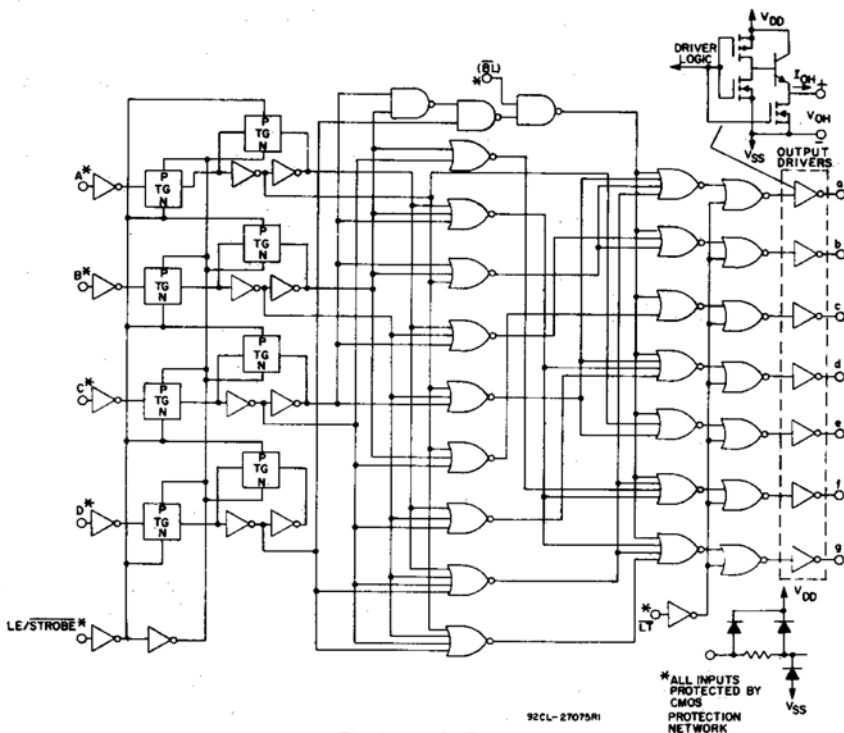


Fig. 8 - Logic diagram.

TRUTH TABLE														
LE	BI	LT	D	C	B	A	a	b	c	d	e	f	g	Display
X	X	0	X	X	X	X	1	1	1	1	1	1	1	8
X	0	1	X	X	X	X	0	0	0	0	0	0	0	Blank
0	1	1	0	0	0	0	1	1	1	1	1	1	0	0
0	1	1	0	0	0	1	0	1	1	0	0	0	0	1
0	1	1	0	0	1	0	1	1	0	1	1	0	1	2
0	1	1	0	0	1	1	1	1	1	0	0	1	1	3
0	1	1	0	1	0	0	0	1	1	0	0	1	1	4
0	1	1	0	1	0	1	1	0	1	1	0	1	1	5
0	1	1	0	1	1	0	0	0	1	1	1	1	1	6
0	1	1	0	1	1	1	1	1	1	0	0	0	0	7
0	1	1	1	0	0	0	1	1	1	1	1	1	1	8
0	1	1	1	0	0	1	1	1	1	0	0	1	1	9
0	1	1	1	0	1	0	0	0	0	0	0	0	0	Blank
0	1	1	1	0	1	1	0	0	0	0	0	0	0	Blank
0	1	1	1	1	0	0	0	0	0	0	0	0	0	Blank
0	1	1	1	1	0	1	0	0	0	0	0	0	0	Blank
0	1	1	1	1	1	0	0	0	0	0	0	0	0	Blank
1	1	1	X	X	X	X			*					*

X = Don't Care

* Depends on BCD code previously applied when LE = 0

Note: Display is blank for all illegal input codes (BCD > 1001).

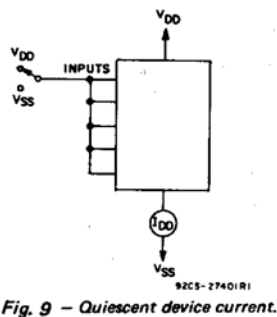


Fig. 9 - Quiescent device current.

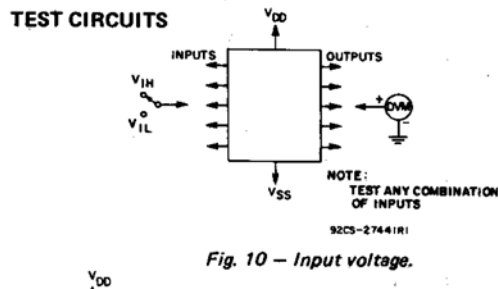


Fig. 10 - Input voltage.

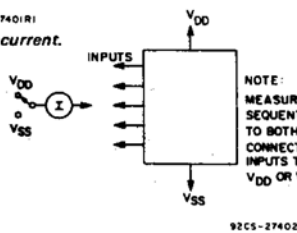


Fig. 11 - Input current.

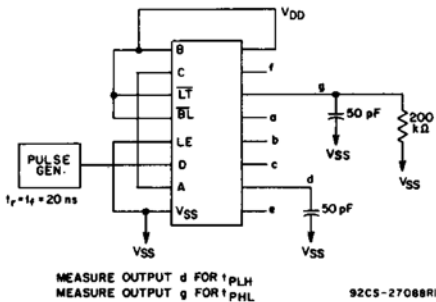


Fig. 12 - Data propagation delay.

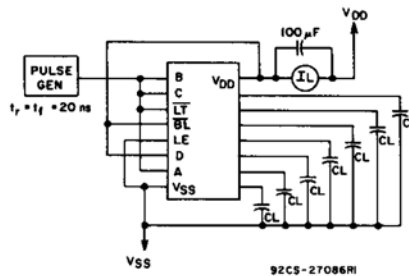


Fig. 13 - Dynamic power dissipation.

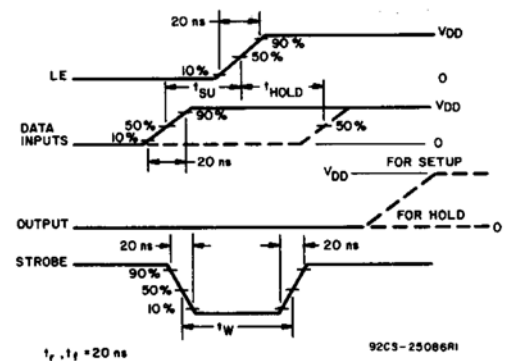
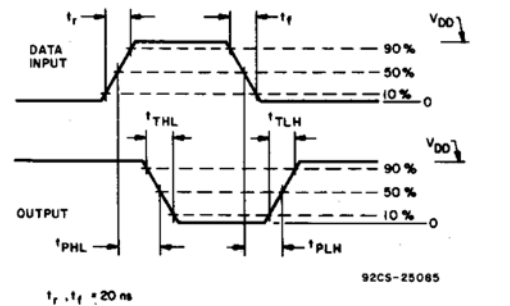
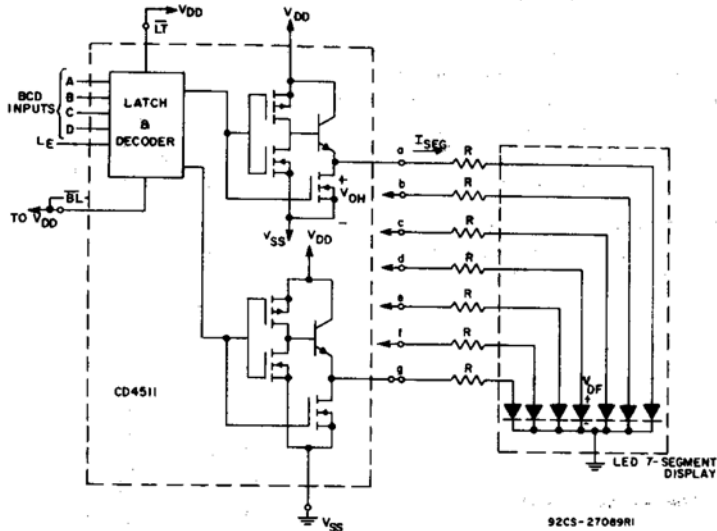


Fig. 14 - Dynamic waveforms.

CD4511B Types

APPLICATIONS Interfacing with Various Displays

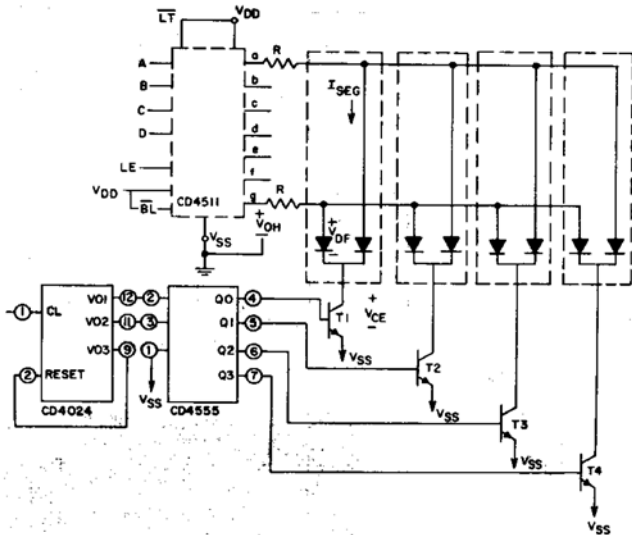


Duty Cycle = 100%

$I_{SEG} = I_{DIODE_{AVG}} = 20 \text{ mA}$ at Luminous Intensity/Segment = 250 microcandles

$$R = \frac{V_{OH} - V_{DF}}{I_{SEG}}$$

Fig. 15 - Driving common-cathode 7-segment LED displays (example Hewlett-Packard 5082-7740).



Multiplexing Scheme Showing 2 of 7 Segments Connected

Transistors T_1 – T_4 (RCA-2N3053 or 2N2102) have I_C Max. rating $> 7 \times I_{SEG}$

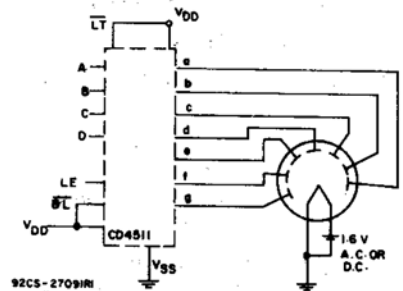
Duty Cycle = 25%

$I_{SEG} = (I_{DIODE_{AVG}}) \times 4$

$$R = \frac{(V_{OH} - V_{DF} - V_{CE})}{I_{SEG}}$$

All unused inputs on CD4555 are connected to V_{DD} or V_{SS} .

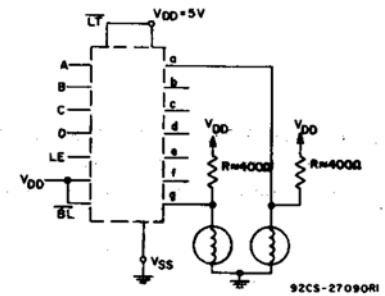
Fig. 18 - Multiplexing with common-cathode 7-segment LED displays (example Hewlett-Packard 5082-7404 4 character display or 4 discrete Monosanto Man 3 displays).



A medium-brightness intensity display can be obtained with low-voltage fluorescent displays such as the Tung-Sol Digivac S/G** Series.

**Trademark Tung-Sol Division Wagner Electric Co.

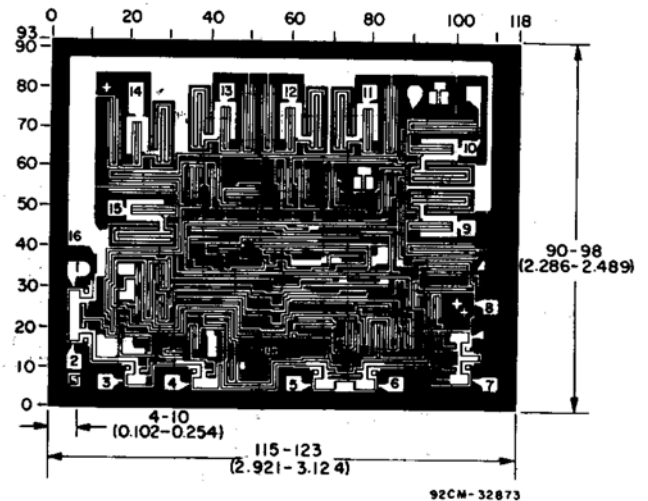
Fig. 16 - Driving low-voltage fluorescent displays.



2 of 7 Segments Shown Connected

Resistors R from V_{DD} to each 7-segment driver output are chosen to keep all Numitron segments slightly on and warm.

Fig. 17 - Driving incandescent displays (RCA Numitron DR2000 series displays).



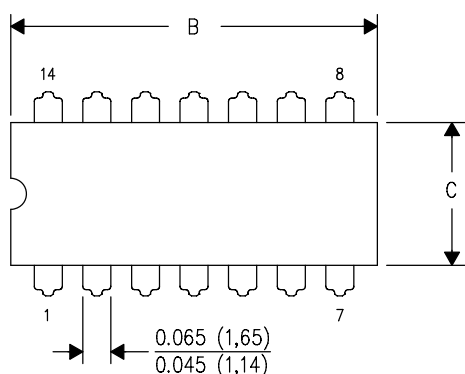
Dimensions and pad layout for CD4511B chip.

Dimensions in parentheses are in millimeters and are derived from the basic inch dimensions as indicated. Grid graduations are in mils (10^{-3} inch).

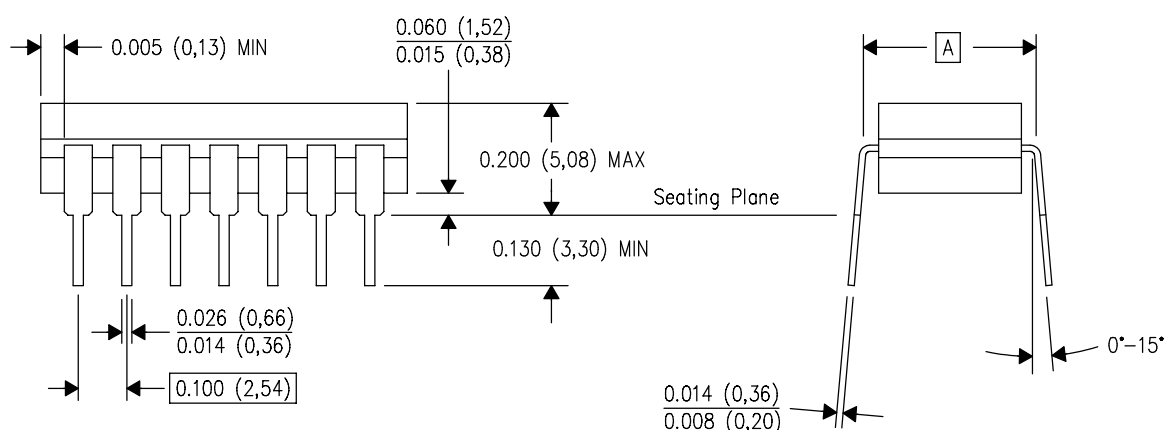
J (R—GDIP—T**)

14 LEADS SHOWN

CERAMIC DUAL IN—LINE PACKAGE



DIM \ PINS **	14	16	18	20
A	0.300 (7,62) BSC	0.300 (7,62) BSC	0.300 (7,62) BSC	0.300 (7,62) BSC
B MAX	0.785 (19,94)	.840 (21,34)	0.960 (24,38)	1.060 (26,92)
B MIN	—	—	—	—
C MAX	0.300 (7,62)	0.300 (7,62)	0.310 (7,87)	0.300 (7,62)
C MIN	0.245 (6,22)	0.245 (6,22)	0.220 (5,59)	0.245 (6,22)



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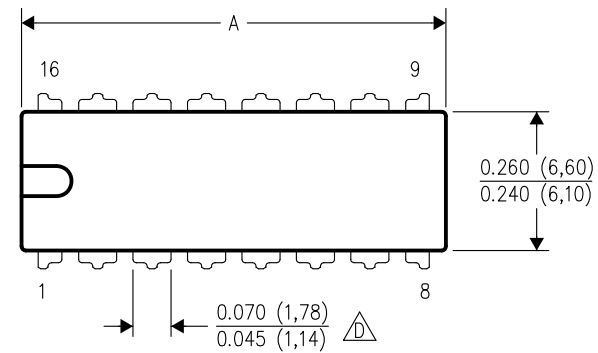
- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - C. This package is hermetically sealed with a ceramic lid using glass frit.
 - D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
 - E. Falls within MIL STD 1835 GDIP1—T14, GDIP1—T16, GDIP1—T18 and GDIP1—T20.

MECHANICAL DATA

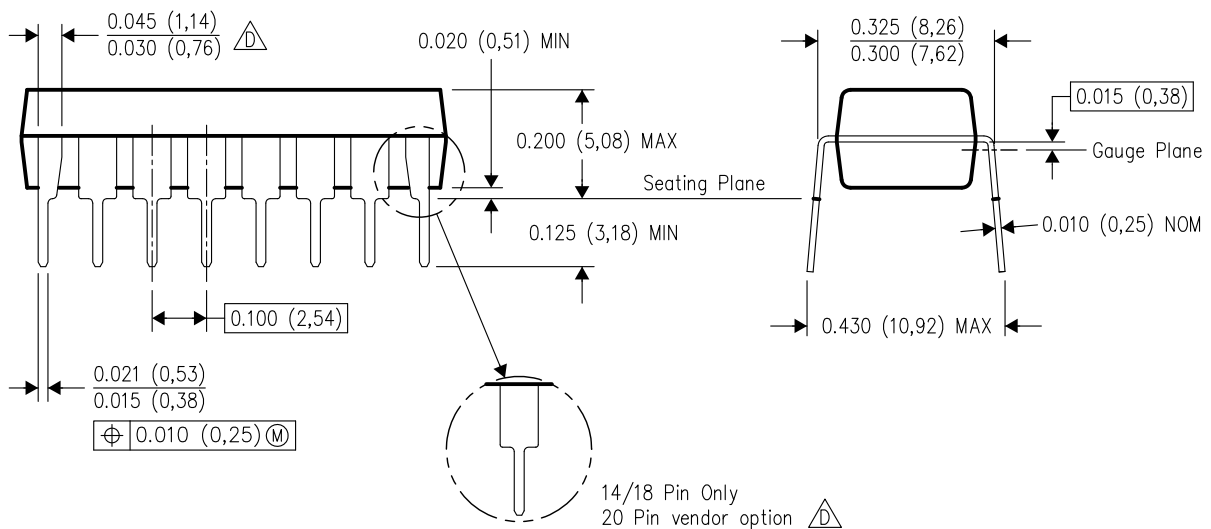
N (R-PDIP-T**)

16 PINS SHOWN

PLASTIC DUAL-IN-LINE PACKAGE



DIM \ PINS **	14	16	18	20
A MAX	0.775 (19,69)	0.775 (19,69)	0.920 (23,37)	1.060 (26,92)
A MIN	0.745 (18,92)	0.745 (18,92)	0.850 (21,59)	0.940 (23,88)
MS-001 VARIATION	AA	BB	AC	AD



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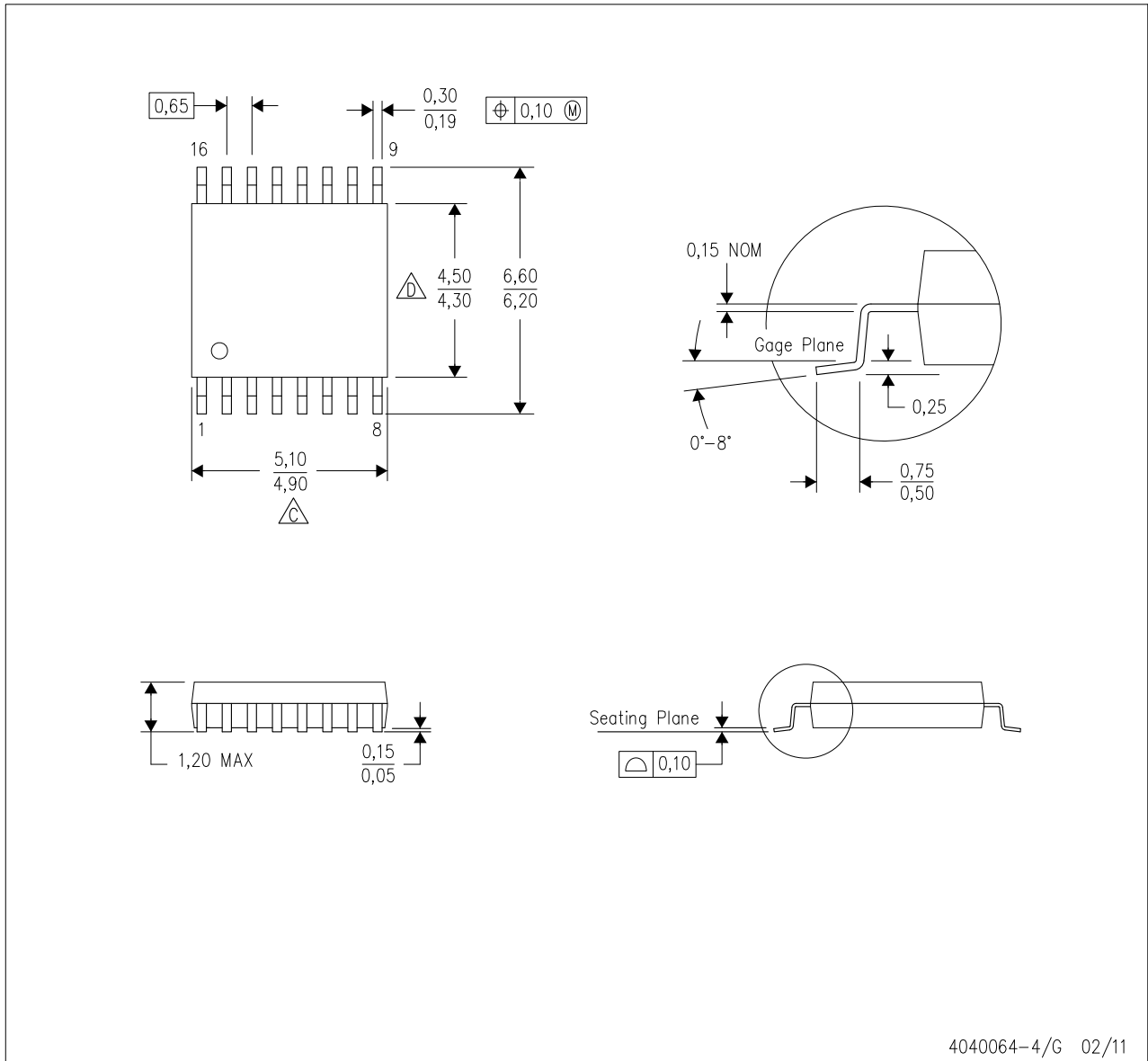
NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
-  Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
-  The 20 pin end lead shoulder width is a vendor option, either half or full width.

MECHANICAL DATA

PW (R-PDSO-G16)

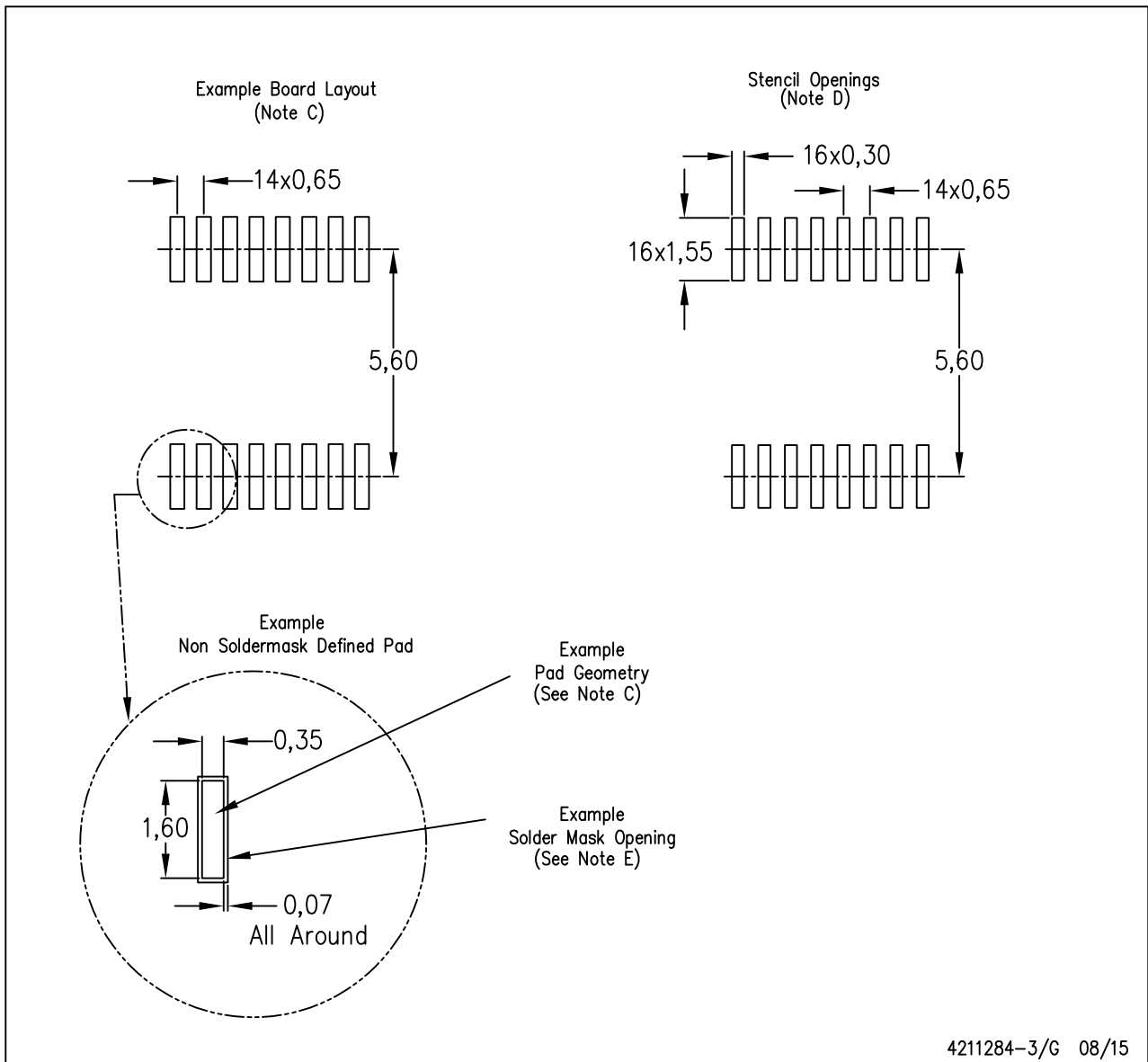
PLASTIC SMALL OUTLINE



- NOTES:
- A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.
 - B. This drawing is subject to change without notice.
 - $\triangle$ C Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0,15 each side.
 - $\triangle$ D Body width does not include interlead flash. Interlead flash shall not exceed 0,25 each side.
 - E. Falls within JEDEC MO-153

PW (R-PDSO-G16)

PLASTIC SMALL OUTLINE



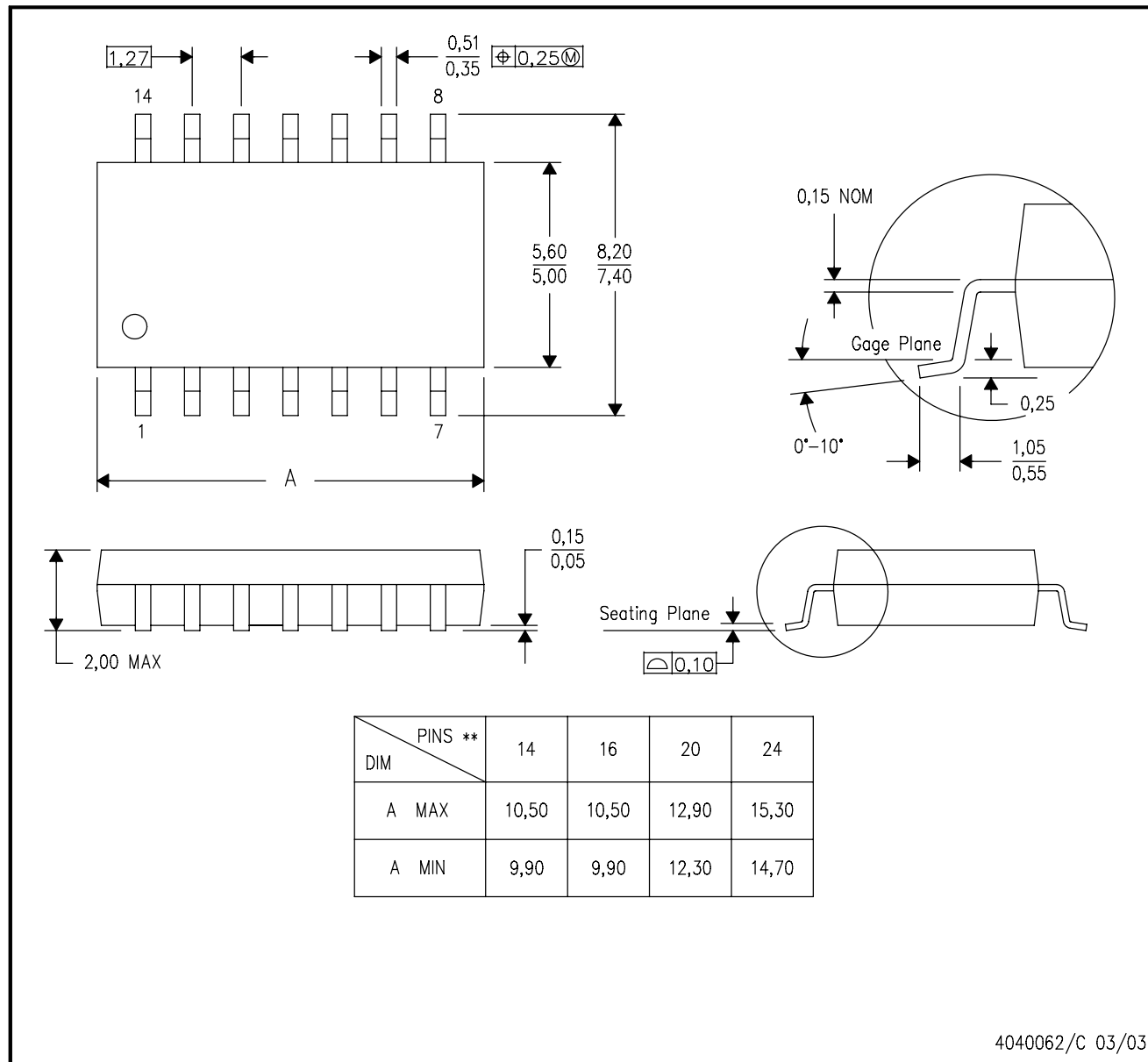
- NOTES:
- A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.
 - C. Publication IPC-7351 is recommended for alternate designs.
 - D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
 - E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.

MECHANICAL DATA

NS (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

14-PINS SHOWN



- NOTES:
- A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.
 - C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.